

## Product Summary

$V_{(BR)DSS}$	$R_{DS(ON)} \text{ max}$	$I_D \text{ max}$ $T_c = +25^\circ\text{C}$
30V	4m $\Omega$ @ $V_{GS} = 10\text{V}$	75A
	7m $\Omega$ @ $V_{GS} = 4.5\text{V}$	75A

## Description

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## Applications

- Power Management Functions
- DC-DC Converters
- Backlighting

## Features

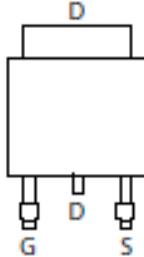
- Low On-Resistance
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

## Mechanical Data

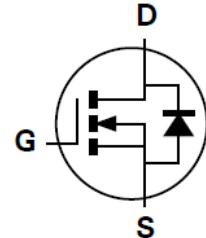
- Case:TO252
- Case Material: Molded Plastic, "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Matte Tin Finish.
- Solderable per MIL-STD-202, Method 208 ③
- Weight: 0.315 grams (Approximate)



Top View



Pin Out Top View



Equivalent Circuit

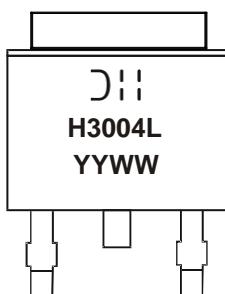
## Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH3004LK3-13	TO252	2500/Tape & Reel

Notes:

- EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



DII = Manufacturer's Marking  
H3004L = Product Type Marking Code  
YYWW = Date Code Marking  
YY = Last Two Digits of Year (ex: 15 = 2015)  
WW = Week Code (01 to 53)

**Maximum Ratings** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			$V_{DSS}$	30	V
Gate-Source Voltage			$V_{GSS}$	+20 -16	V
Continuous Drain Current (Note 6) $V_{GS} = 10\text{V}$	Steady State	$T_C = +25^\circ\text{C}$ $T_C = +70^\circ\text{C}$	$I_D$	75 75	A
	Steady State	$T_A = +25^\circ\text{C}$ $T_A = +70^\circ\text{C}$	$I_D$	21 17	A
Pulsed Drain Current (380 $\mu\text{s}$ Pulse, Duty Cycle=1%)			$I_{DM}$	160	A
Maximum Continuous Body Diode Forward Current (Note 6)			$I_S$	3	A
Avalanche Current (Note 7) $L=5\text{mH}$			$I_{AS}$	10.7	A
Avalanche Energy (Note 7) $L=5\text{mH}$			$E_{AS}$	287	mJ

**Thermal Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		$P_D$	1.9	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	$R_{\theta JA}$	80	°C/W
Total Power Dissipation (Note 6)		$P_D$	3	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	$R_{\theta JA}$	50	°C/W
Thermal Resistance, Junction to Case		$R_{\theta JC}$	1.4	°C/W
Operating and Storage Temperature Range		$T_J, T_{STG}$	-55 to +175	°C

**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS (Note 8)</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	30	-	-	V	$V_{GS} = 0\text{V}, I_D = 1\text{mA}$
Zero Gate Voltage Drain Current	$I_{DSS}$	-	-	10	$\mu\text{A}$	$V_{DS} = 24\text{V}, V_{GS} = 0\text{V}$
Gate-Source Leakage	$I_{GS}$	-	-	100 -100	nA	$V_{GS} = +20\text{V}, V_{DS} = 0\text{V}$ $V_{GS} = -16\text{V}, V_{DS} = 0\text{V}$
<b>ON CHARACTERISTICS (Note 8)</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	1	-	3	V	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$
Static Drain-Source On-Resistance	$R_{DS(ON)}$	-	3.3	4	$\text{m}\Omega$	$V_{GS} = 10\text{V}, I_D = 20\text{A}$
		-	5.5	7		$V_{GS} = 4.5\text{V}, I_D = 7\text{A}$
Diode Forward Voltage	$V_{SD}$	-	0.75	1	V	$V_{GS} = 0\text{V}, I_S = 1\text{A}$
<b>DYNAMIC CHARACTERISTICS (Note 9)</b>						
Input Capacitance	$C_{iss}$	-	2370	-	pF	$V_{DS} = 15\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$
Output Capacitance	$C_{oss}$	-	1360	-	pF	
Reverse Transfer Capacitance	$C_{rss}$	-	240	-	pF	
Gate Resistance	$R_g$	-	0.6	-	$\Omega$	
Total Gate Charge ( $V_{GS} = 4.5\text{V}$ )	$Q_g$	-	20	-	nC	$V_{DS} = 15\text{V}, I_D = 20\text{A}$
Total Gate Charge ( $V_{GS} = 10\text{V}$ )	$Q_g$	-	44	-	nC	
Gate-Source Charge	$Q_{gs}$	-	7	-	nC	
Gate-Drain Charge	$Q_{gd}$	-	8	-	nC	
Turn-On Delay Time	$t_{D(ON)}$	-	6.2	-	ns	$V_{DD} = 15\text{V}, V_{GS} = 10\text{V}, R_L = 0.75\Omega, R_G = 3\Omega, I_D = 20\text{A}$
Turn-On Rise Time	$t_R$	-	4.3	-	ns	
Turn-Off Delay Time	$t_{D(OFF)}$	-	21	-	ns	
Turn-Off Fall Time	$t_F$	-	8	-	ns	
Reverse Recovery Time	$t_{RR}$	-	25	-	ns	$I_F = 15\text{A}, di/dt=500\text{A}/\mu\text{s}$
Reverse Recovery Charge	$Q_{RR}$	-	37	-	nC	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

 7.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J = +25^\circ\text{C}$ .

8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.

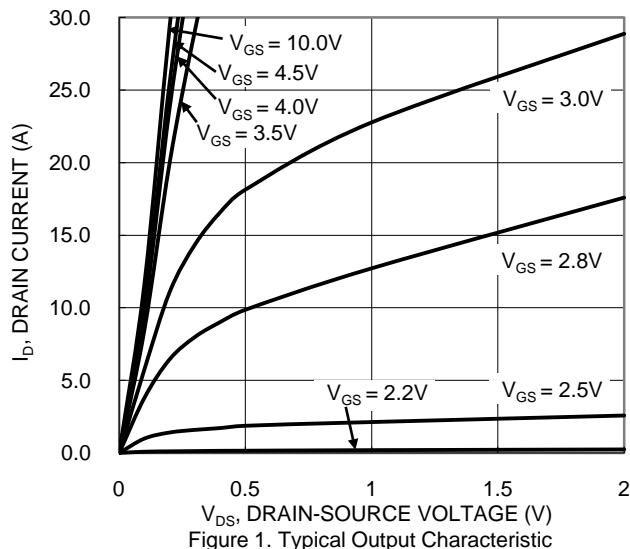


Figure 1. Typical Output Characteristic

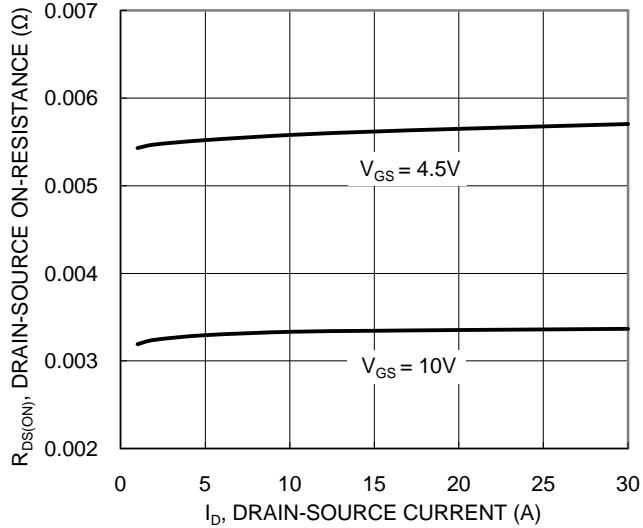


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

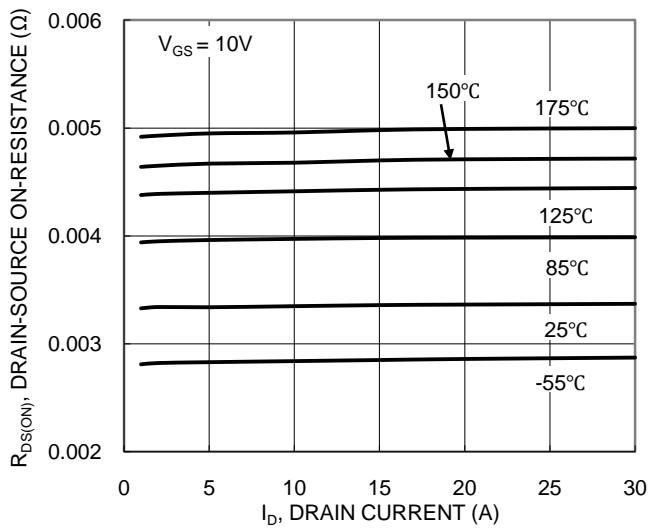


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

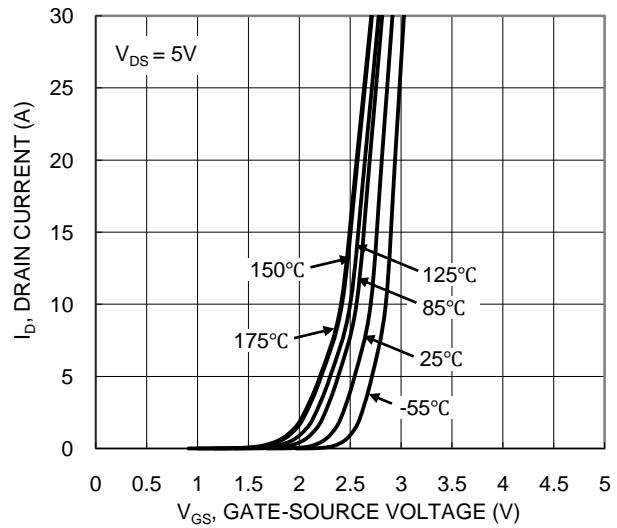


Figure 2. Typical Transfer Characteristic

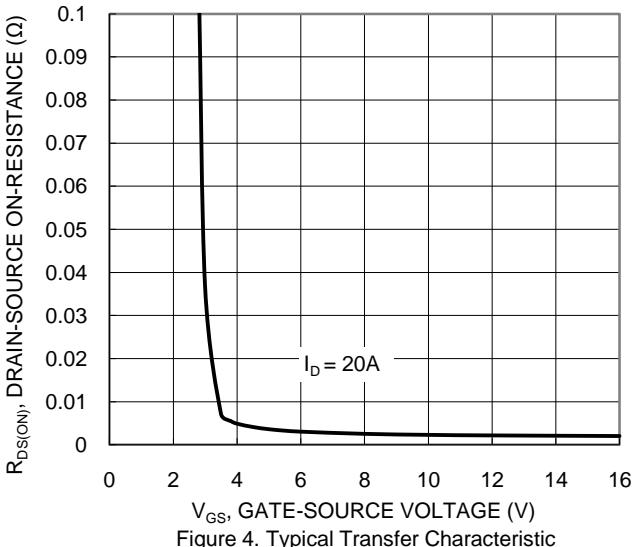


Figure 4. Typical Transfer Characteristic

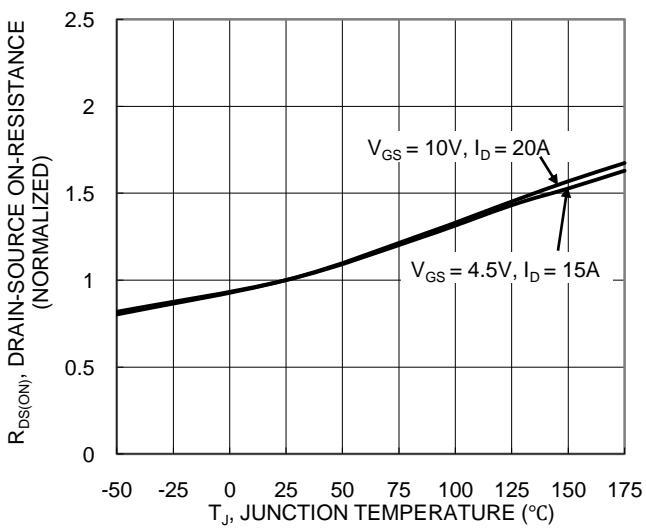


Figure 6. On-Resistance Variation with Junction Temperature

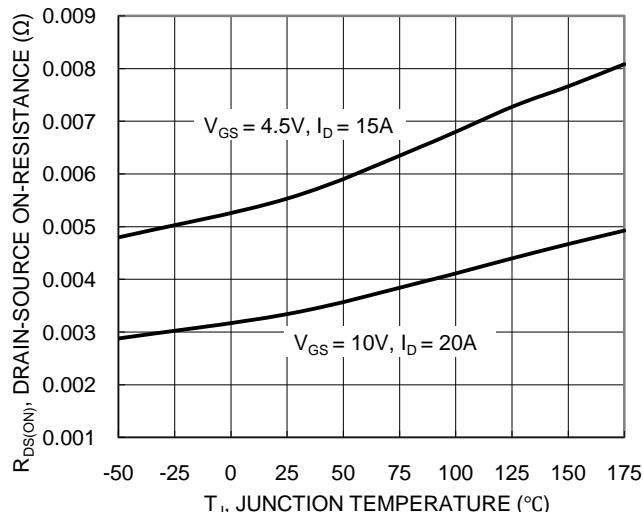


Figure 7. On-Resistance Variation with Junction Temperature

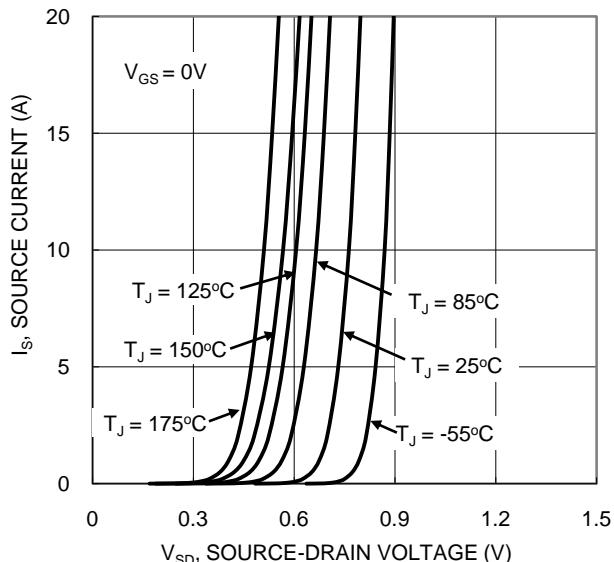


Figure 9. Diode Forward Voltage vs. Current

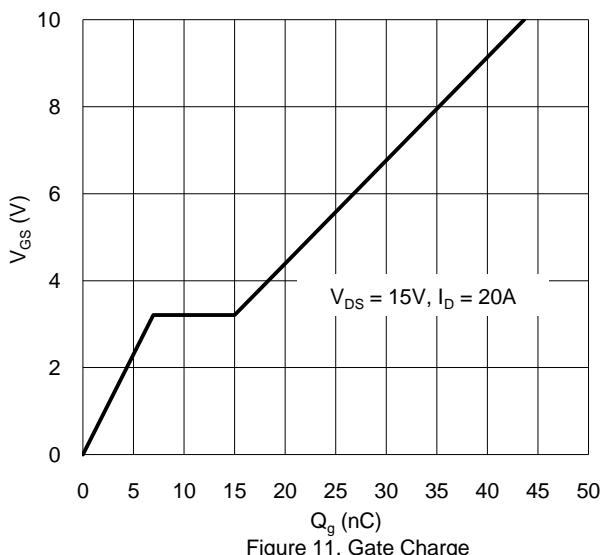


Figure 11. Gate Charge

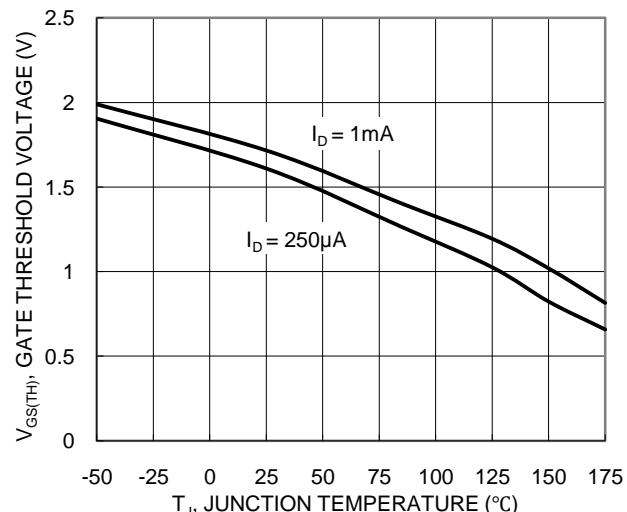


Figure 8. Gate Threshold Variation vs. Junction Temperature

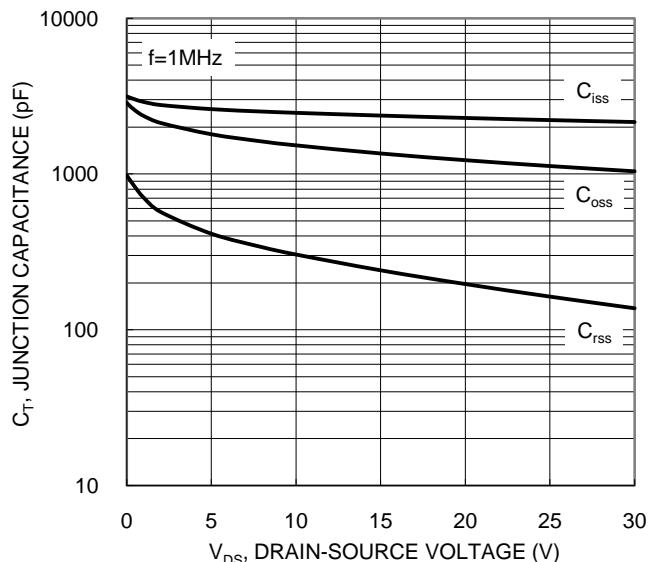


Figure 10. Typical Junction Capacitance

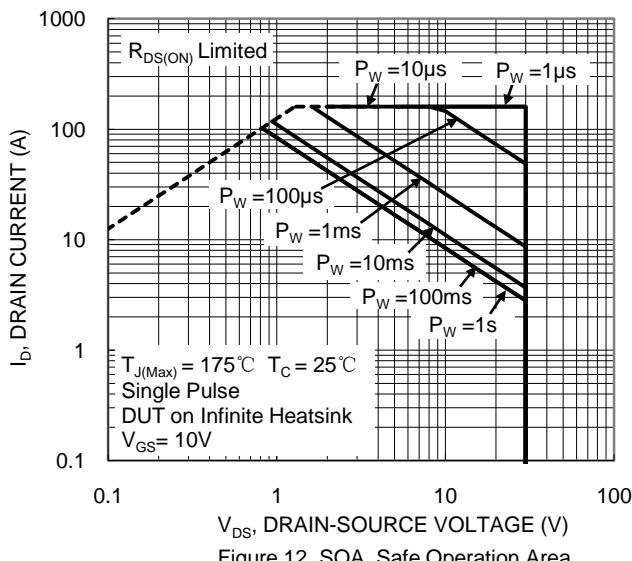
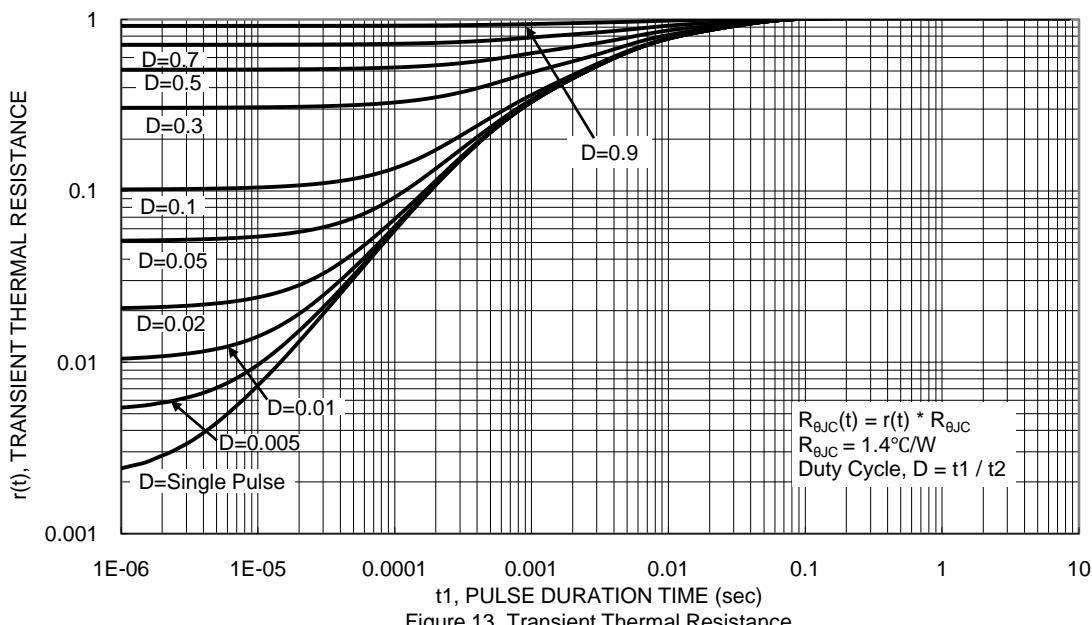
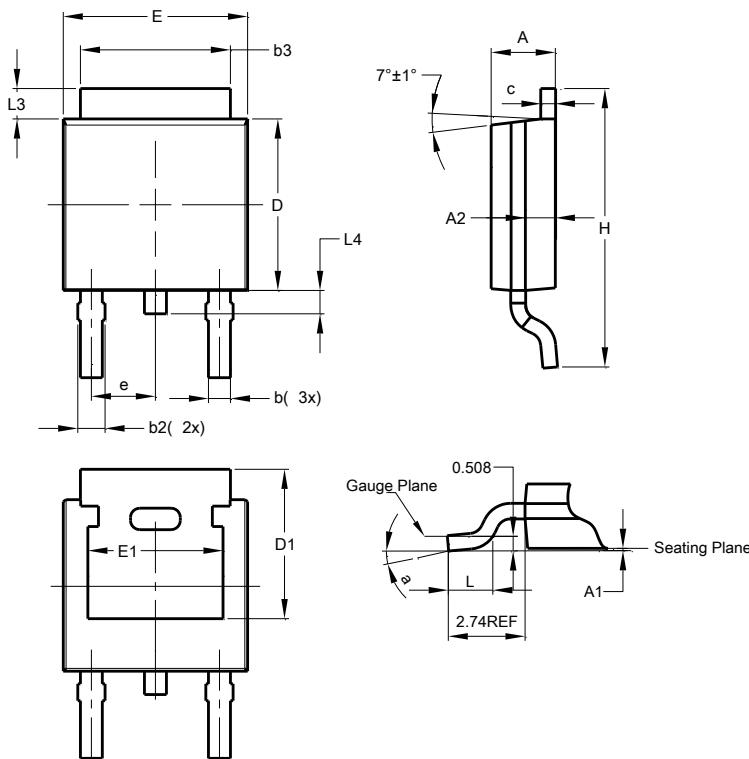


Figure 12. SOA, Safe Operation Area



## Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

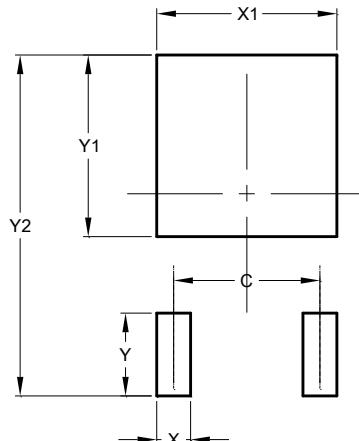


TO252 (DPAK)			
Dim	Min	Max	Typ
<b>A</b>	2.19	2.39	2.29
<b>A1</b>	0.00	0.13	0.08
<b>A2</b>	0.97	1.17	1.07
<b>b</b>	0.64	0.88	0.783
<b>b2</b>	0.76	1.14	0.95
<b>b3</b>	5.21	5.46	5.33
<b>c</b>	0.45	0.58	0.531
<b>D</b>	6.00	6.20	6.10
<b>D1</b>	5.21	-	-
<b>e</b>	-	-	2.286
<b>E</b>	6.45	6.70	6.58
<b>E1</b>	4.32	-	-
<b>H</b>	9.40	10.41	9.91
<b>L</b>	1.40	1.78	1.59
<b>L3</b>	0.88	1.27	1.08
<b>L4</b>	0.64	1.02	0.83
<b>a</b>	0°	10°	-

All Dimensions in mm

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	4.572
X	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700

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